TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74LVX125FN

Quad Bus Buffer

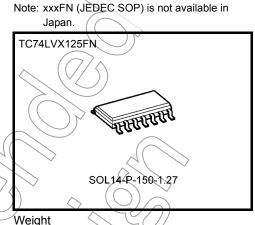
The TC74LVX125FN is a high-speed CMOS quad bus buffer fabricated with silicon gate CMOS technology. Designed for use in 3-V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation. This device is suitable for low-voltage and battery operated systems.

This device requires the 3-state control input G to be set high to place the output into the high-impedance.

An input protection circuit ensures that 0 to 5.5V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5V to 3V systems and two supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.

Features

- High-speed: $t_{pd} = 4.4 \text{ ns} (typ.) (V_{CC} = 3.3 \text{ V})$
- Low power dissipation: $I_{CC} = 4 \mu A (max) (Ta = 25 \phi)$
- Input voltage level: $V_{IL} = 0.8 V (max) (V_{CC} = 3V)$
 - $V_{IH} = 2.0 V (min) (V_{CC} = 3 V)$
- Power-down protection is provided on all inputs
- Balanced propagation delays: $t_{pLH} \simeq t_{pHL}$
- Low noise: $V_{OLP} = 0.5 V (max)$
- Pin and function compatible with 74HC125

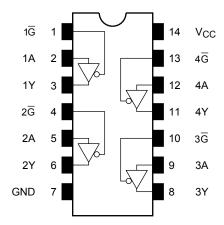


SOL14-P-150-1.27

: 0.12 g (typ.)

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Pin Assignment (top view)



Truth Table

Inp	Outputs	
G	А	Y
Н	Х	Z
L	L	L
L	Н	Н

X: Don't care

Z: High impedance

Absolute Maximum Ratings (Note)

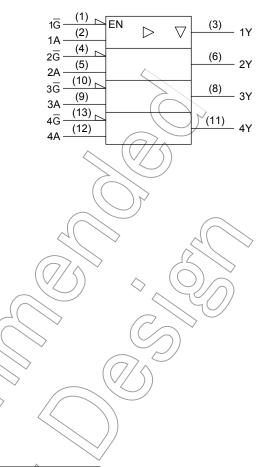
Characteristics	Symbol	Rating	Unit
Supply voltage range	Xcc	-0.5 tø 7.0	\sim
DC input voltage	<i>Ο</i> y _{in}	-0.5 to 7.0	> v
DC output voltage		-0.5 to V _{CC} + 0.5	V
Input diode current	IIK	-20	mA
Output diode current	lok	+20	mA
DC output current	IOUT	±25	mA
DC V _{CC} /ground current	lçç	↓±50	mA
Power dissipation	(PD	180	mW
Storage temperature	Tstg	–65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

IEC Logic Symbol



Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V _{CC}	2.0 to 3.6	V
Input voltage	V _{IN}	0 to 5.5	V
Output voltage	V _{OUT}	0 to V _{CC}	V
Operating temperature	T _{opr}	-40 to 85	°C
Input rise and fall time	dt/dv	0 to 100	ns/V

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.

Electrical Characteristics

DC Characteristics

						4	\searrow		AL		
Characteristics Symbol Test Condition		Symbol	Symbol Test Condition		Ta = 25°C			;	Ta = - 85	Unit	
			Vcc (V)	Min	Тур.	Max	Min	Max			
					2.0	1.5	_	\sim	1.5	_	
	H-level	VIH	VIH - (30	2.0	-((2.0		
Input voltage					3.6	2.4		Z	2.4		V
input voltage				\square	2.0	_ ($(H \langle$	0.5		0.5	v
	L-level	V_{IL}	$\langle \langle \rangle$		3.0))	0.8		0.8	
					3.6			0.8		0.8	
				IOH = -50 μA	2.0	7.9	/2.0	_	1.9	—	
	H-level	V _{OH}	VIN = VIH or VIL	10H = -50 μA	3.0	2.9	3.0	_	2.9		
Output voltage				I _{OH} = -4 mA	3.0	2.58		_	2.48	—	V
Output voltage				l _{OL} = 50 μA _	2:0	$\rangle -$	0	0.1		0.1	v
	L-level	Vol	V _{IN} = V _{IH} or V _{IL}	l _{OL} = 50 μA	3.0		0	0.1		0.1	
		\sum	$I_{OL} = 4 \text{ mA}$		3.0			0.36		0.44	
3-state output	$\langle \langle \rangle$		VIN = VIH OF VIL		3.6			±0.25		±2.5	μA
Off-state current		loz	VOUT = VCC or GND		5.0			±0.25		±2.0	μA
Input leakage cur	rent	YIN	V _{IN} = 5.5 V or GND		3.6	—	—	±0.1	—	±1.0	μA
Quiescent supply	current	ICC	$V_{IN} = V_{CC} \text{ or } GND$		3.6	—	—	4.0	—	40.0	μA

AC Characteristics (input: $t_r = t_f = 3 \text{ ns}$)

Characteristics	Symbol	Test Condition	n		Ta = 25°C			Ta = -40 to 85°C		Unit
			V _{CC} (V)	C _L (pF)	Min	Тур.	Max	Min	Max	
Propagation delay time	+	_	2.7	15	_	5.8	10.1	1.0	13.5	ns
	t _{pLH}			50		8.3 <	13.6	1.0	17.0	
			3.3 ± 0.3	15		4.4	6.2	1.0	8.5	
	tpHL		5.5 ± 0.5	50		6.9	9.7	0.14	12.0	
Output enable time	t _{pZL}	$R_L = 1 \ k\Omega$	2.7	15		5,3	9.3	1.0	12.5	
				50	\leftarrow	7.8	12.8	1.0	16.0	
	t _{pZH}		3.3 ± 0.3	15	- 2	4.0	5.6	1.0	7.5	
				50	_((6.5	9.1	1.0	11.0	
Output disable time	t _{pLZ}	$R_L = 1 \ k\Omega$	2.7	50		10.0	15.7	1.0	19.0	ns
	t _{pHZ}		$\textbf{3.3}\pm\textbf{0.3}$	50 <		8.3	11.2	<1(0	13.0	115
Output to output skew	t _{osLH}	(Note 1)	2.7	50	\geq	_	1.5	$\langle \rangle$	> 1.5	ns
	t _{osHL}		$\textbf{3.3}\pm\textbf{0.3}$	50	$) \rightarrow$	\neg	1.5		1.5	115
Input capacitance	CIN		((Note 2)		4	70	4	10	pF
Output capacitance	C _{OUT}			\bigcirc		6	(> –	_	pF
Power dissipation capacitance	C _{PD}		4	(Note 3)		14	$\langle \mathcal{A} \rangle$	_	_	pF

Note 1: Parameter guaranteed by design.

 $(t_{osLH} = |t_{pLHm} - t_{pLHn}|, t_{osHL} = |t_{pHLm} - t_{pHLn}|)$

Note 2: Parameter guaranteed by design.

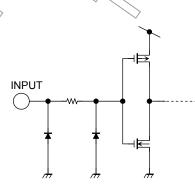
Note 3: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption. Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/4$ (per bit)

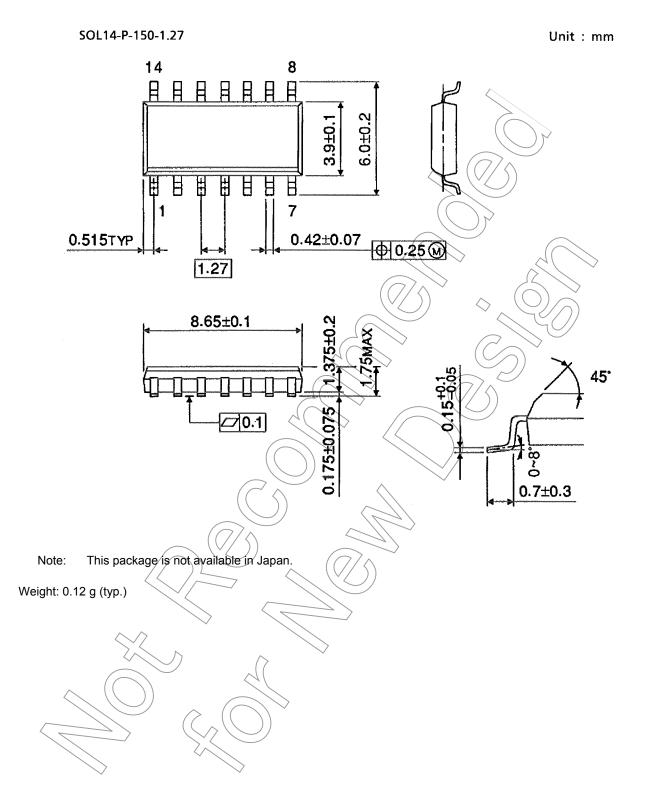
Noise Characteristics (Ta = 25°C, input: $t_r = t_f = 3 \text{ ns}$, $C_L = 50 \text{ pF}$)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Limit	Unit
Quiet output maximum Vo	DL VOLP		3.3	0.3	0.5	V
Quiet output minimum Vo		-	3.3	-0.3	-0.5	V
Minimum high level dynamic V	н Vінр	_	3.3	_	2.0	V
Maximum low level dynamic V		> -	3.3		0.8	V

Input Equivalent Circuit



Package Dimensions (Note)



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